

**TRADEMARK ASSIGNMENT**

Electronic Version v1.1  
 Stylesheet Version v1.1

<b>SUBMISSION TYPE:</b>		NEW ASSIGNMENT	
<b>NATURE OF CONVEYANCE:</b>		SECURITY INTEREST	
<b>CONVEYING PARTY DATA</b>			
<b>Name</b>	<b>Formerly</b>	<b>Execution Date</b>	<b>Entity Type</b>
Omni Life Science, Inc.		08/20/2010	CORPORATION: DELAWARE
<b>RECEIVING PARTY DATA</b>			
<b>Name:</b>	Silicon Valley Bank		
<b>Street Address:</b>	One Newton Executive Park		
<b>Internal Address:</b>	2221 Washington Street, Suite 200		
<b>City:</b>	Newton		
<b>State/Country:</b>	MASSACHUSETTS		
<b>Postal Code:</b>	02462		
<b>Entity Type:</b>	Bank: CALIFORNIA		
<b>PROPERTY NUMBERS Total: 2</b>			
<b>Property Type</b>	<b>Number</b>	<b>Word Mark</b>	
<b>Registration Number:</b>	3600179	OMNI LIFE SCIENCE	
<b>Registration Number:</b>	3596557		
<b>CORRESPONDENCE DATA</b>			
<b>Fax Number:</b>	(703)519-1821		
	<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>		
<b>Phone:</b>	703-415-1555		
<b>Email:</b>	mail@specializedpatent.com		
<b>Correspondent Name:</b>	Christopher E. Kondracki		
<b>Address Line 1:</b>	1725 Duke Street		
<b>Address Line 2:</b>	Suite 625		
<b>Address Line 4:</b>	Alexandria, VIRGINIA 22314		
<b>ATTORNEY DOCKET NUMBER:</b>	1008809TM		
<b>NAME OF SUBMITTER:</b>	Christopher E. Kondracki		

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**TRADEMARK  
 REEL: 004270 FRAME: 0047**

Signature:	/Christopher E. Kondracki/
Date:	08/30/2010
Total Attachments: 7 source=Omni#page1.tif source=Omni#page2.tif source=Omni#page3.tif source=Omni#page4.tif source=Omni#page5.tif source=Omni#page6.tif source=Omni#page7.tif	

## INTELLECTUAL PROPERTY SECURITY AGREEMENT

This Intellectual Property Security Agreement is entered into as of August 20, 2010 by and between **SILICON VALLEY BANK** (“**Bank**”) and **OMNI LIFE SCIENCE, INC.** (“**Grantor**”).

### RECITALS

A. Bank has agreed to make certain advances of money and to extend certain financial accommodation to Grantor (the “**Loans**”) in the amounts and manner set forth in that certain Loan and Security Agreement by and between Bank and, among others, Grantor dated as of the date hereof (as the same may be amended, modified or supplemented from time to time, the “**Loan Agreement**”; capitalized terms used herein are used as defined in the Loan Agreement). Bank is willing to make the Loans to Grantor, but only upon the condition, among others, that Grantor shall grant to Bank a security interest in certain Copyrights, Trademarks, Patents, and Mask Works (as each term is described below) to secure the obligations of Grantor under the Loan Agreement.

B. Pursuant to the terms of the Loan Agreement, Grantor has granted to Bank a security interest in all of Grantor's right, title and interest, whether presently existing or hereafter acquired, in, to and under all of the Collateral.

NOW, THEREFORE, for good and valuable consideration, receipt of which is hereby acknowledged, and intending to be legally bound, as collateral security for the prompt and complete payment when due of its obligations under the Loan Agreement, Grantor hereby represents, warrants, covenants and agrees as follows:

### AGREEMENT

To secure its obligations under the Loan Agreement, Grantor grants and pledges to Bank a security interest in all of Grantor's right, title and interest in, to and under its intellectual property (all of which shall collectively be called the “**Intellectual Property Collateral**”), including, without limitation, the following:

1. Any and all copyright rights, copyright applications, copyright registrations and like protections in each work or authorship and derivative work thereof, whether published or unpublished and whether or not the same also constitutes a trade secret, now or hereafter existing, created, acquired or held, including without limitation those set forth on Exhibit A attached hereto (collectively, the “**Copyrights**”);
2. Any and all trade secrets, and any and all intellectual property rights in computer software and computer software products now or hereafter existing, created, acquired or held;
3. Any and all design rights that may be available to Grantor now or hereafter existing, created, acquired or held;

4. All patents, patent applications and like protections including, without limitation, improvements, divisions, continuations, renewals, reissues, extensions and continuations-in-part of the same, including without limitation the patents and patent applications set forth on Exhibit B attached hereto (collectively, the “**Patents**”);

5. Any trademark and servicemark rights, whether registered or not, applications to register and registrations of the same and like protections, and the entire goodwill of the business of Grantor connected with and symbolized by such trademarks, including without limitation those set forth on Exhibit C attached hereto (collectively, the “**Trademarks**”);

6. All mask works or similar rights available for the protection of semiconductor chips, now owned or hereafter acquired, including, without limitation those set forth on Exhibit D attached hereto (collectively, the “**Mask Works**”);

7. Any and all claims for damages by way of past, present and future infringements of any of the rights included above, with the right, but not the obligation, to sue for and collect such damages for said use or infringement of the intellectual property rights identified above;

8. All licenses or other rights to use any of the Copyrights, Patents, Trademarks, or Mask Works and all license fees and royalties arising from such use to the extent permitted by such license or rights;

9. All amendments, extensions, renewals and extensions of any of the Copyrights, Trademarks, Patents, or Mask Works; and

10. All proceeds and products of the foregoing, including without limitation all payments under insurance or any indemnity or warranty payable in respect of any of the foregoing.

This security interest is granted in conjunction with the security interest granted to Bank under the Loan Agreement. The rights and remedies of Bank with respect to the security interest granted hereby are in addition to those set forth in the Loan Agreement and the other Loan Documents, and those which are now or hereafter available to Bank as a matter of law or equity. Each right, power and remedy of Bank provided for herein or in the Loan Agreement or any of the Loan Documents, or now or hereafter existing at law or in equity shall be cumulative and concurrent and shall be in addition to every right, power or remedy provided for herein and the exercise by Bank of any one or more of the rights, powers or remedies provided for in this Intellectual Property Security Agreement, the Loan Agreement or any of the other Loan Documents, or now or hereafter existing at law or in equity, shall not preclude the simultaneous or later exercise by any person, including Bank, of any or all other rights, powers or remedies.

[Signature page follows.]

IN WITNESS WHEREOF, the parties have caused this Intellectual Property Security Agreement to be duly executed by its officers thereunto duly authorized as of the first date written above.

GRANTOR:

Address of Grantor:

50 O'Connell Way  
Taunton, Massachusetts 02780  
Attn: Mr. George B. Cipolletti

OMNI LIFE SCIENCE, INC.


By:   
Name: George B. Cipolletti  
Title: President

BANK:

Address of Bank:

One Newton Executive Park, Suite 200  
2221 Washington Street  
Newton, Massachusetts 02462  
Attn: Mr. Michael Foley

SILICON VALLEY BANK

By:   
Name: Michael Foley  
Title: VP

[Signature Page to Intellectual Property Security Agreement -Omni Life]

EXHIBIT A

Copyrights

Description

Registration/  
Application  
Number

Registration/  
Application  
Date

none

## EXHIBIT B

### Patents

<u>Description</u>	<u>Number</u>	<u>Date</u>
IMPLANTABLE JOINT PROSTHESIS, US patent	6702854	09-Mar-2004
JOINT PROSTHESES AND COMPONENTS THEREOF, US patent	7044975	16-May-2006
TAPERED JOINT PROSTHESIS, US patent	7572297	11-Aug-2009
TAPERED JOINT PROSTHESIS, Japanese application (pending)	2006-534427	08-Oct-2004
TAPERED JOINT PROSTHESIS, Australian application (pending)	2004280263	08-Oct-2004
TAPERED JOINT PROSTHESIS, German application (pending)	11 2004 001 893.5	08-Oct-2004
CROSSLINKED POLYETHYLENE ARTICLE, US application (pending)	11/917603	13-Jun-2006
CROSSLINKED POLYETHYLENE ARTICLE, Japanese application (pending)	2008-516992	13-Jun-2006
CROSSLINKED POLYETHYLENE ARTICLE, Australian application (pending)	2006259555	13-Jun-2006
CROSSLINKED POLYETHYLENE ARTICLE, European application (pending)	06784796.2	13-Jun-2006
MODULAR KNEE PROSTHESIS, US application (pending)	11/066123	25-Feb-2005
MODULAR KNEE PROSTHESIS, Australian patent	2005216267	26-Feb-2009
MODULAR KNEE PROSTHESIS, German application (pending)	112005000431.7	28-Feb-2005

EXHIBIT C

Trademarks


<u>Trademark Description</u>	<u>Number</u>	<u>Date</u>
OMNI life science, US registered trademark	3,600,179	31-Mar-2009
 , US registered trademark	3,596,557	24-Mar-2009



EXHIBIT D

Mask Works

Description

Registration/  
Application  
Number

Registration/  
Application  
Date

none

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